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FS4468

## N-Channel 30-V (D-S) MOSFET

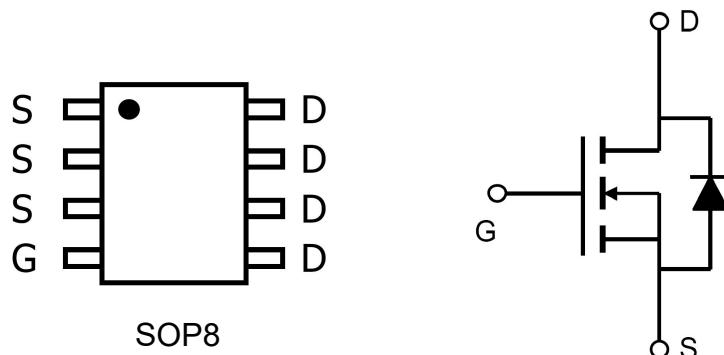
### ● FEATURES

$V_{DS}$	30V
$I_D$ (at $V_{GS}=10V$ )	12A
$R_{DS(ON)}$ (at $V_{GS}=10V$ )	11mΩ (TYP)
$R_{DS(ON)}$ (at $V_{GS} = 4.5V$ )	15mΩ (TYP)
ESD Protected	

### ● GENERAL DESCRIPTION

The FS4468 combines advanced trench MOSFET technology with a low resistance package to provide extremely low  $R_{DS(ON)}$ . This device is ideal for load switch and battery protection applications.

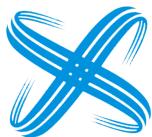
### ● PIN CONFIGURATION



### ● Absolute Maximum Ratings

$T_A=25^\circ C$  unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	$V_{DS}$	30	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current $T_A=25^\circ C$	$I_D$	13.5	A
$T_A=70^\circ C$	$I_D$	12	
Pulsed Drain Current <sup>C</sup>	$I_{DM}$	53	
Avalanche Current <sup>C</sup>	$I_{AS}, I_{AR}$	22	A
Avalanche energy $L=0.1mH$ <sup>C</sup>	$E_{AS}, E_{AR}$	18	mJ
Power Dissipation <sup>B</sup>	$P_D$	3.1	W
$T_A=70^\circ C$	$P_D$	2	
Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to 150	°C



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● Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>STATIC PARAMETERS</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$I_D=250\mu\text{A}, V_{GS}=0\text{V}$	30			V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{DS}=30\text{V}, V_{GS}=0\text{V}$			1	uA
$I_{\text{GSS}}$	Gate-Body leakage current	$V_{DS}=0\text{V}, V_{GS}=\pm 20\text{V}$			$\pm 15$	
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	1	1.8	3	V
$R_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$V_{GS}=10\text{V}, I_D=10\text{A}$		11	14	$\text{m}\Omega$
		$V_{GS}=4.5\text{V}, I_D=8\text{A}$		15	22	
$V_{\text{SD}}$	Diode Forward Voltage	$I_S=2.3\text{A}, V_{GS}=0\text{V}$		0.75		V
<b>DYNAMIC PARAMETERS</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=15\text{V}, f=1\text{MHz}$		720		pF
$C_{\text{oss}}$	Output Capacitance			120		
$C_{\text{rss}}$	Reverse Transfer Capacitance			37		
$R_g$	Gate resistance	$V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$		0.8		$\Omega$
<b>SWITCHING PARAMETERS</b>						
$Q_g$	Total Gate Charge	$V_{GS}=10\text{V}, V_{DS}=15\text{V}, I_D=10\text{A}$		19		nC
$Q_g$	Total Gate Charge	$V_{GS}=4.5\text{V}, V_{DS}=15\text{V}, I_D=10\text{A}$		9.7		
$Q_{gs}$	Gate Source Charge			3.8		
$Q_{gd}$	Gate Drain Charge			4		
$t_{D(\text{on})}$	Turn-On DelayTime	$V_{DD}=25\text{V}, R_L=25\Omega, I_D=1\text{A}, V_{\text{GEN}}=10\text{V}$ $R_G=6\Omega$		12		ns
$t_r$	Turn-On Rise Time			9		
$t_{D(\text{off})}$	Turn-Off DelayTime			42		
$t_f$	Turn-Off Fall Time			6		

A. The value of  $R_{\theta JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25^\circ\text{C}$ . The value in any given application depends on the user's specific board design.

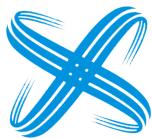
B. The power dissipation  $P_D$  is based on  $T_{J(\text{MAX})}=150^\circ\text{C}$ , using  $\leq 10\text{s}$  junction-to-ambient thermal resistance.

C. Repetitive rating, pulse width limited by junction temperature  $T_{J(\text{MAX})}=150^\circ\text{C}$ . Ratings are based on low frequency and duty cycles to keep initial  $T_J=25^\circ\text{C}$ .

D. The  $R_{\theta JA}$  is the sum of the thermal impedance from junction to lead  $R_{\theta JL}$  and lead to ambient.

E. The static characteristics in Figures 1 to 6 are obtained using <300us pulses, duty cycle 0.5% max.

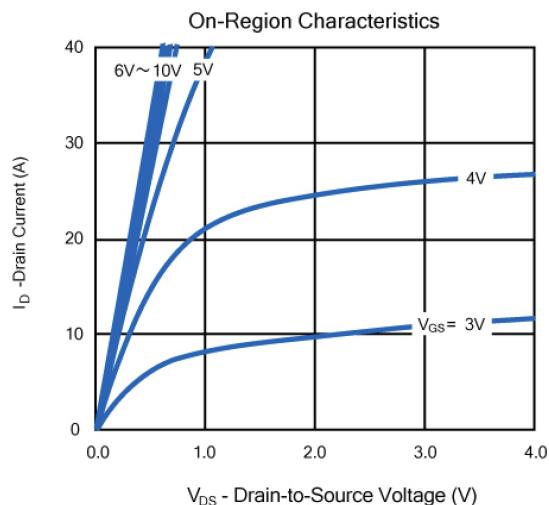
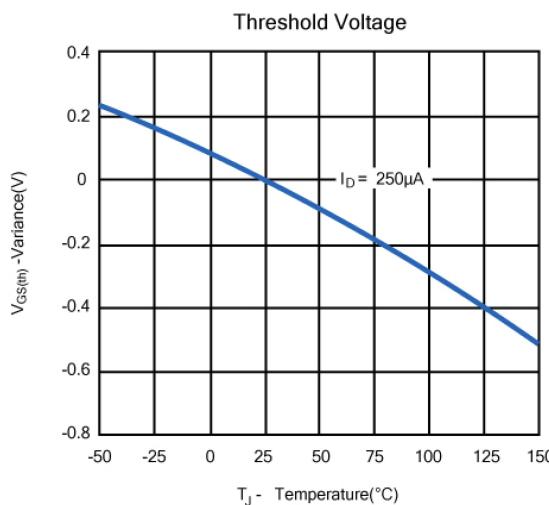
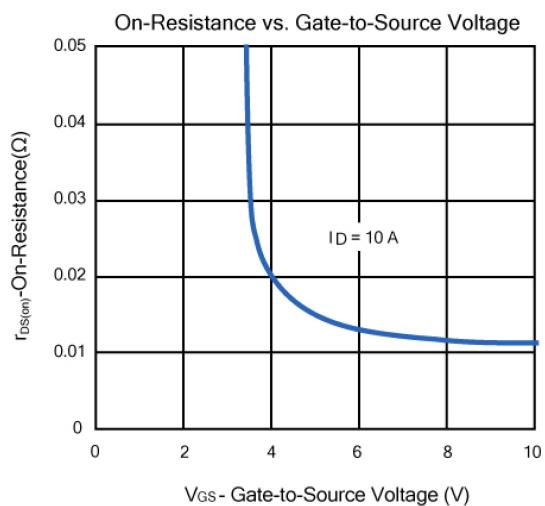
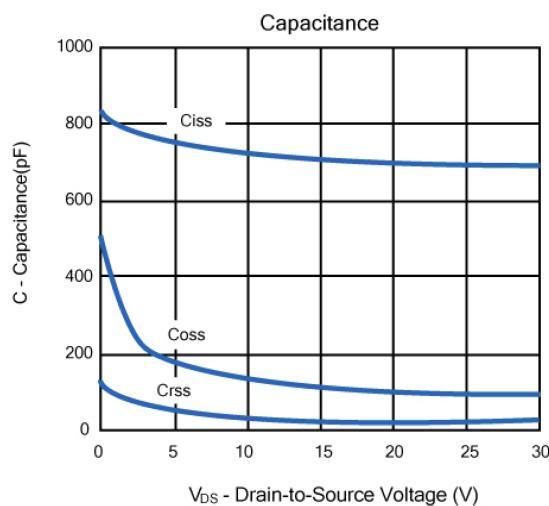
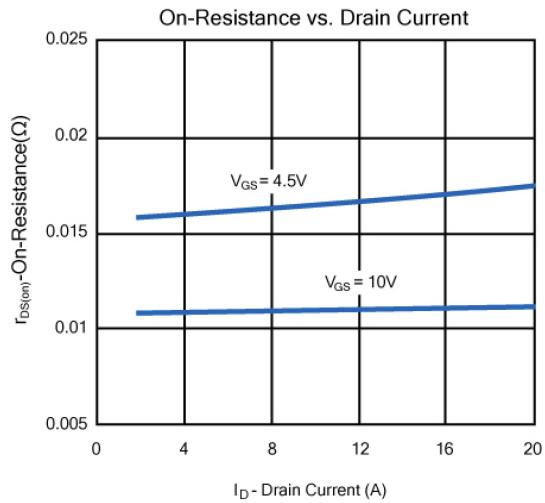
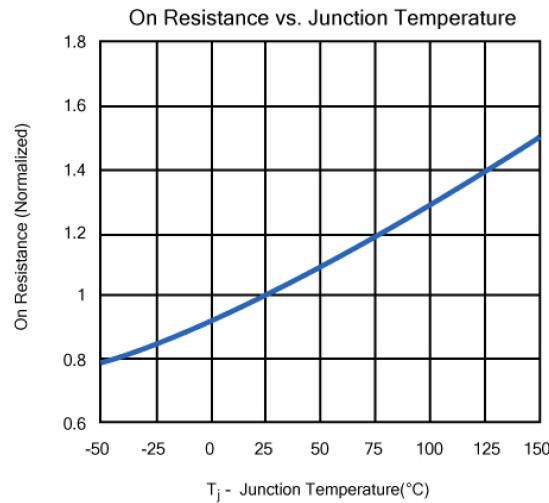
F. These curves are based on the junction-to-ambient thermal impedance which is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, assuming a maximum junction temperature of  $T_{J(\text{MAX})}=150^\circ\text{C}$ . The SOA curve provides a single pulse rating.

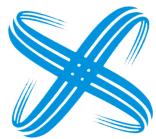


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- TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS





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